

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Dong-Kil SHIN, et al.

Serial No.: 10/772,651 Examiner: Warren, Matthew E.

Filed: February 4, 2004 Group Art Unit: 2815

Confirmation No.: 5815

For: MULTI-CHIP PACKAGE WITH SOFT ELEMENT AND METHOD OF  
MANUFACTURING THE SAME

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**AMENDMENT**

Responsive to the Office Action, Paper No. 20060531, dated June 15, 2006, please  
amend the application as follows.

**A complete listing of the Claims** begins on page 2 of this paper.

**Remarks** begin on page 6 of this paper.